



/ Revised record



/ Descriptions

BRCL3230ME / BRCL3230ME

MOSFET

BRCL3230ME SOT23-5

BRCL3230ME

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The BRCL3230ME series product is a high integration solution for lithium-ion/polymer battery protection. BRCL3230ME contains advanced power MOSFET, high-accuracy voltage detection circuits and delay circuits.

BRCL3230ME is put into an ultra-small SOT23-5 package makes it an ideal solution in limited space of battery pack. BRCL3230ME has all the protection functions required in the battery application including overcharging, overdischarging, overcurrent and load short circuiting protection etc. The low standby current drains little current from the cell while in storage. The device is not only targeted for digital cellular phones, but also for any other Li-Ion and Li-Poly battery-powered information appliances requiring long-term battery life.

/ Features

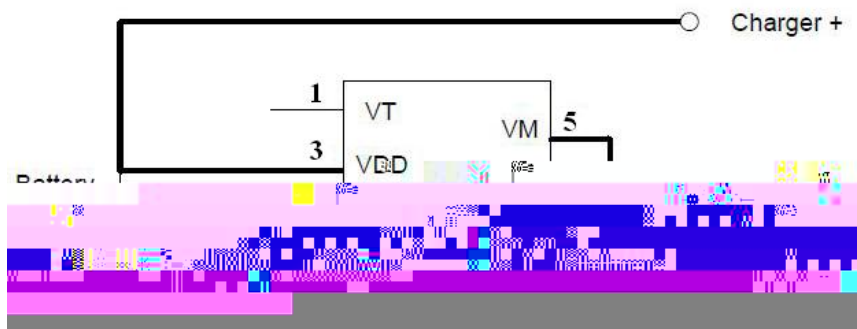
- ◆ 1 05 » ¼ MOSFET ½
- ◆ ¾ SOT23-5 ½
- ◆ RC ½
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- ◆ Integrate advanced power MOSFET with Equivalent of 45mΩ R_{DS(ON)};
- ◆ Ultra-small SOT23-5 package;
- ◆ Internal integration RC without any peripheral devices;
- ◆ Over-temperature Protection;
- ◆ Overcharge Current Protection;
- ◆ Three-step Overcurrent Detection: Overdischarge Current1, Overdischarge Current2, Load Short Circuiting;
- ◆ Charger detection function;
- ◆ 0V battery charging function, delay times are generated inside, High-accuracy voltage detection.
- ◆ Low Current Consumption, Operation Mode: 2.8µA typ, Power-down Mode: 1.6µA typ ;
- ◆ HF Product;

/ Applications

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One-Cell lithium-ion battery pack; Lithium-Polymer battery pack.

/ Typical Application



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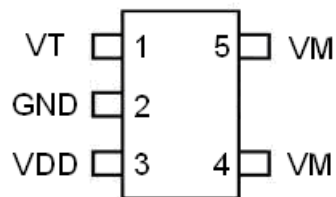
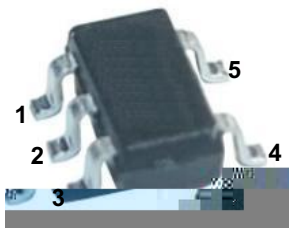
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Notes:

- (1) The chip power consumption shall not exceed the maximum power consumed by the package.
- (2) This product has anti-static protection function, but do not exceed the maximum capacity of the product to withstand static electricity.
- (3) When welding and assembling the battery and protection plate, please confirm that the welding equipment must be grounded to avoid the discharge damage caused by the accumulated charge of the welding equipment.

/ Pinning



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Ç	VT	Test pin
2	GND	Ground, connect the negative terminal of the battery to this pin.
3	VDD	Power Supply
° 5	VM	The negative terminal of the charger. The internal FET switch connects this terminal to GND.

/ Marking

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Parameter	Symbol	Value	Unit
V _{DD} input pin voltage	V _{IN}	-0.3 to +6	V
V _M input pin voltage	V _{VM}	-6 to +10	V
Power Dissipation	P _D	400	mW
Maximum Junction Temperature	T _J	125	°C
Lead Temperature	T _L	300	°C
Operating Junction Temperature	T _{opr}	-40 to +85	°C
Storage Temperature	T _{stg}	-55 to +150	°C
Package Thermal Resistance	R _{θJA}	250	°C/W
	R _{θJC}	130	°C/W
ESD	ESD	2000	V

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Detection voltage						
Overcharge Detection Voltage	V _{OC}	V _{DD} = 4.25V	4.25	4.30		V



Equivalent FET on Resistance						
Equivalent FET on Resistance	R_{DS}	$V_{dd}=3.6V, I_{VM}=1A$		45		mΩ
Over temperature protection						
Over Temperature Protection	OTP		125	140	155	°C
Over Temperature Recovery Degree	OTPR		100	115	130	°C
Delay time						
Overcharge Current Detection Delay Time	T_{OCC}	$V_{dd}=3.6V$	6.4	8	9.6	ms
Overcharge Voltage Detection Delay Time	T_{CU}	$V_{DD}=3.6V\sim 4.4V$	105	135	165	ms
Overdischarge Voltage Detection Delay Time	T_{DL}	$V_{DD}=3.6V\sim 2.0V$	28	35	45	ms
Overdischarge Current1 Detection Delay Time	T_{IOV1}	$V_{DD}=3.6V$	6.4	8	9.6	



/ Functional Description

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The BRCL3230ME monitors the voltage and current of a battery and protects it from being damaged due to overcharge voltage, overdischarge voltage, overdischarge current, and short circuit conditions by



/ Overcharge Condition

The BRCL3230ME detects this voltage and releases the overcharge condition. Consequently, in the case that the battery voltage is equal to or lower than the overcharge detection voltage (VCU), the BRCL3230ME returns to the normal condition immediately, but in the case the battery voltage is higher than the overcharge detection voltage (VCU), the chip does not return to the normal condition until the battery voltage drops below the overcharge detection voltage (VCU) even if the load is connected. In addition, if the VM pin voltage is equal to or lower than the overcurrent 1 detection voltage when a load is connected and discharging starts, the chip does not return to the normal condition.

Note: If the battery is charged to a voltage higher than the overcharge detection voltage (VCU) and the battery voltage does not drop below the overcharge detection voltage (VCU) even when a heavy load, which causes an overcurrent, is connected, the overcurrent 1 and overcurrent 2 do not work until the battery voltage drops below the overcharge detection voltage (VCU). Since an actual battery has, however, an internal impedance of several dozens of mΩ, and the battery voltage drops immediately after a heavy load which causes an overcurrent is connected, the overcurrent 1 and overcurrent 2 work. Detection of load shortcircuiting works regardless of the battery voltage.

/ Overdischarge Condition

When the battery voltage drops below the overdischarge detection voltage (VDL) during discharging under normal condition and it continues for the overdischarge detection delay time (tDL) or longer, the BRCL3230ME turns the discharging control FET off and stops discharging. This condition is called overdischarge condition. After the discharging control FET is turned off, the VM pin is pulled up by the RVMD resistor between VM and VDD in BRCL3230ME the current of the chip is reduced to the power-down current (IPDN). This condition is called power-down condition. The VM and VDD pins are shorted by the RVMD resistor. The power-down condition is released when a charger is connected and the potential difference between VM and VDD becomes typical or higher, at this time, the FET is still off. When the battery voltage becomes the overdischarge detection voltage (VDL) or higher (see note), the BRCL3230ME turns the FET on and changes to the normal condition from the overdischarge condition.

Note: If the VM pin voltage is no less than the charger detection voltage (VCHA), when the battery under overdischarge condition is connected to a charger, the overdischarge condition is released (the discharging control FET is turned on) as usual, provided that the battery voltage reaches the overdischarge release voltage (VDR) or higher.



/ Overcurrent Condition

When the discharging current becomes equal to or higher than a specified value (the VM pin voltage is equal to or higher than the overcurrent detection voltage) during discharging under normal condition and the state continues for the overcurrent detection delay time or longer, the BRCL3230ME turns off the discharging control FET to stop discharging. This condition is called overcurrent condition. (The overcurrent includes overcurrent, or load shortcircuiting.) The VM and GND pins are shorted internally by the RVMS resistor under the overcurrent condition. When a load is connected, the VM pin voltage equals the VDD voltage due to the load.

Because of the connection between the VM and the GND by the RVMS resistor when the load is removed, the VM pin goes back to the GND potential since the VM pin is shorted the GND pin with the RVMS resistor. Detecting that the VM pin potential is lower than the overcurrent detection voltage (VIOV1), the IC returns to the normal condition.

/ Abnormal Charge Current Detection

When the charging current becomes equal to or higher than a specified value (the VM pin voltage is equal to or higher than the abnormal charge current detection voltage) during charging under normal condition and the state continues for the abnormal charge current detection delay time or longer, the BRCL3230ME turns off the charging control FET to stop charging. This condition is called abnormal charge current detection condition. (The abnormal charge current includes abnormal charge current, or load shortcircuiting.) The VM and GND pins are shorted internally by the RVMS resistor under the abnormal charge current detection condition. When a load is connected, the VM pin voltage equals the VDD voltage due to the load.



0V / 0V Battery Charging Function

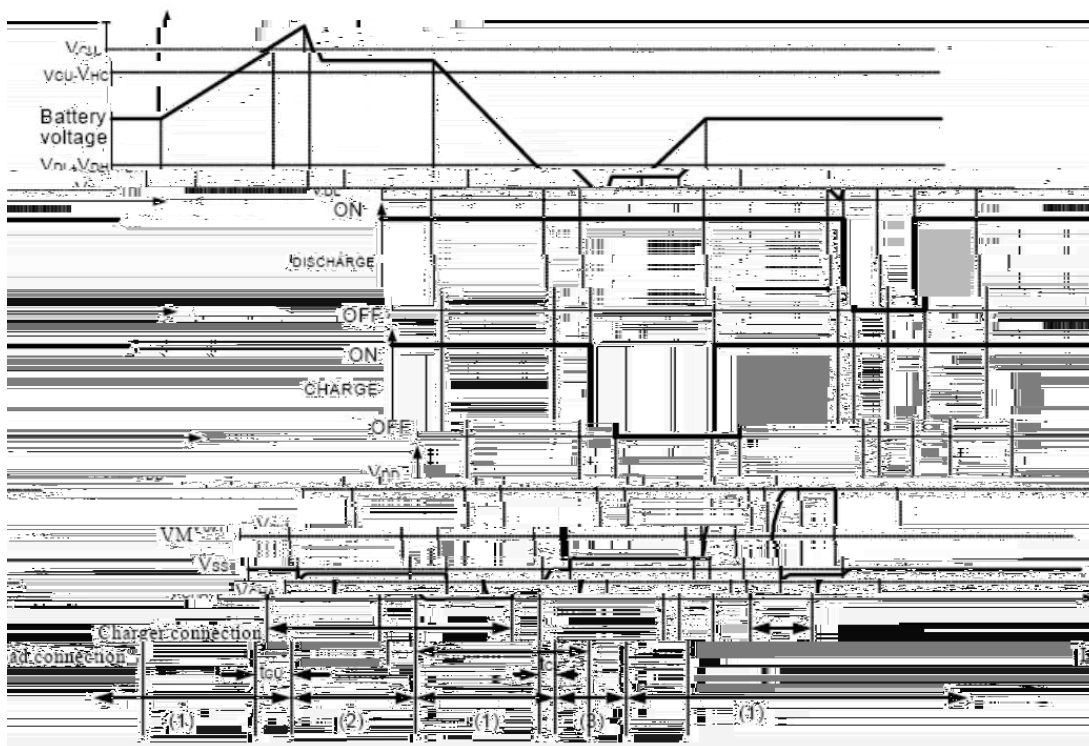
This function enables the charging of a connected battery whose voltage is 0V by self-discharge. When connects to a charger , the discharging control FET is off and the charging current flows through the internal parasitic diode in the discharging control FET. If the battery voltage becomes equal to or higher than the overdischarge release voltage (VDL), the normal condition returns.

Notes:

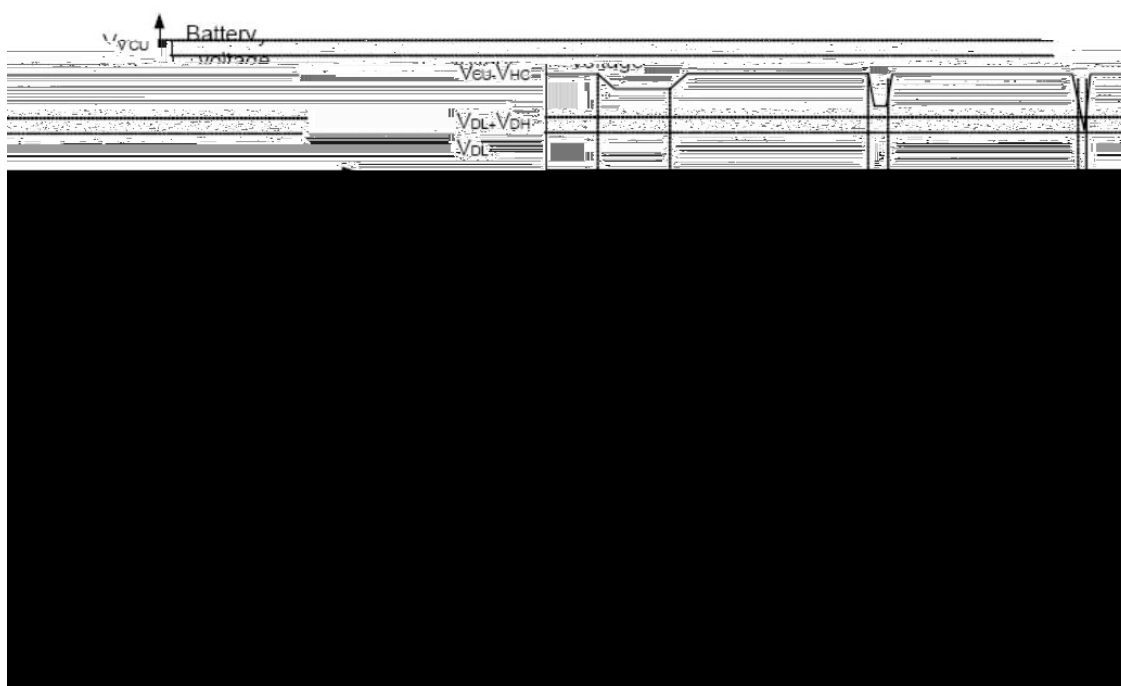
- (1) Some battery providers do not recommend charging of completely discharged batteries. Please refer to battery providers before the selection of 0 V battery charging function.
- (2) The 0V battery charging function has higher priority than the abnormal charge current detection function. Consequently, a product with the 0 V battery charging function charges a battery and abnormal charge current cannot be detected during the battery voltage is low.
- (3) When a battery is connected to the IC for the first time, the IC may not enter the normal condition in which discharging is possible. In this case, set the VM pin voltage equal to the GND voltage (short the VM and GND pins or connect a charger) to enter the normal condition.

/ Timing Chart

/Overcharge And Overdischarge Detection

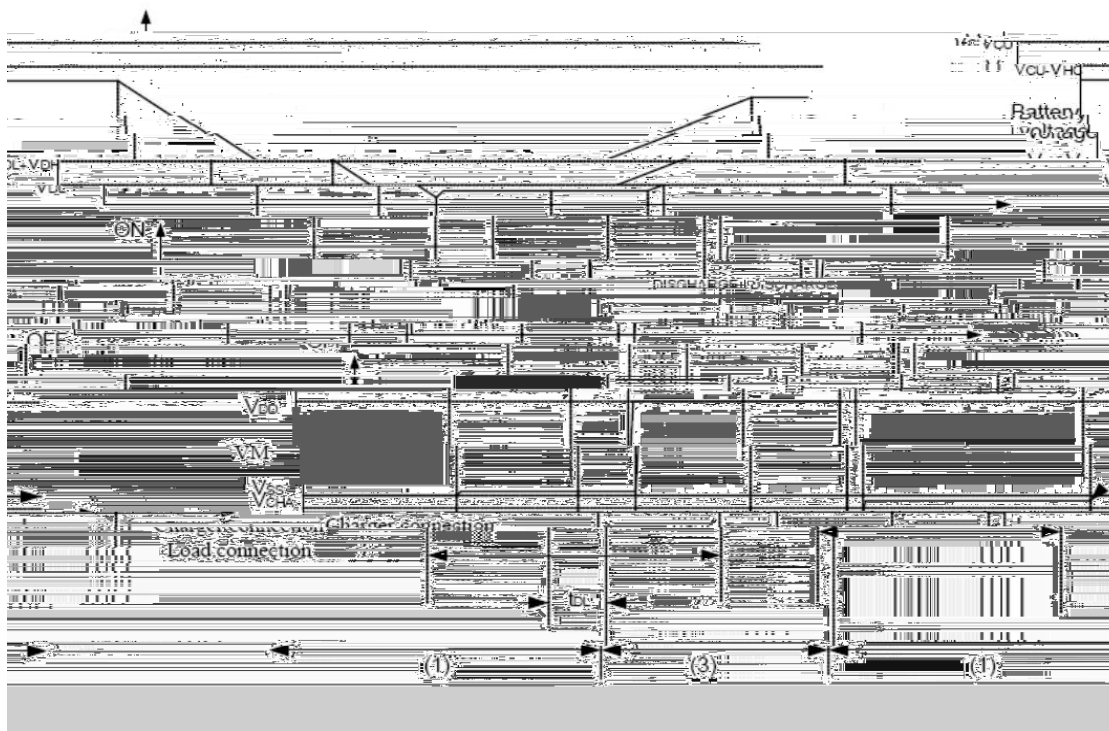


/Overdischarge Current Detection

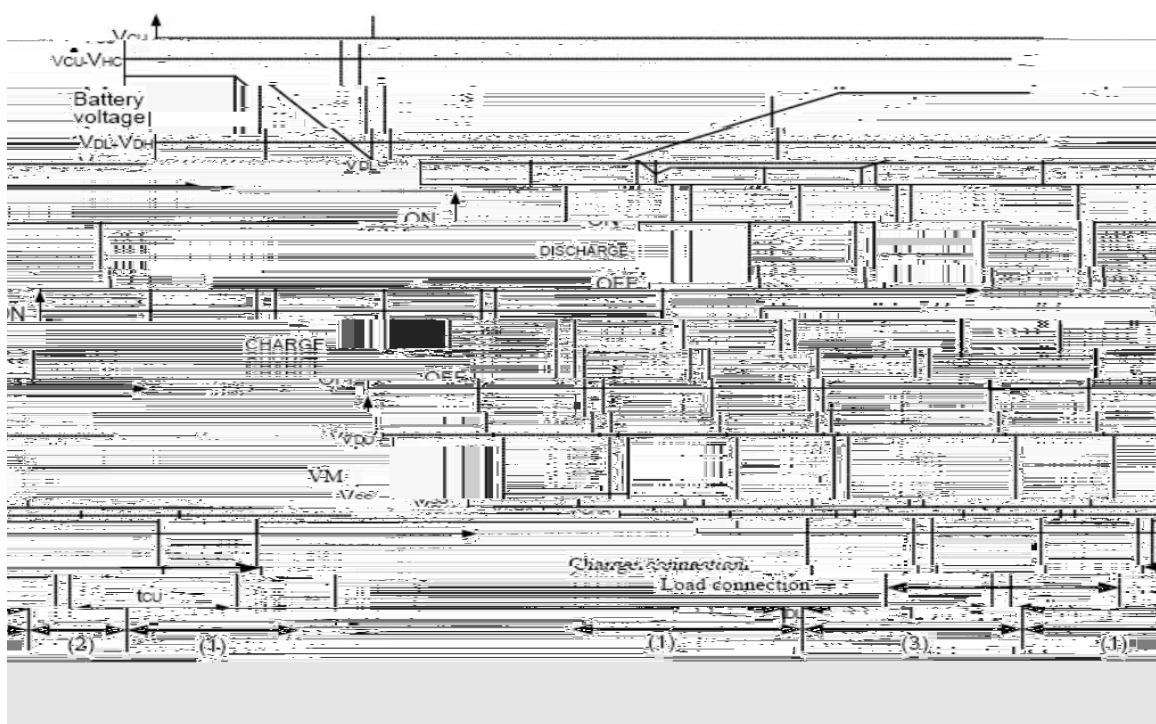


/ Timing Chart

/Charger Detection



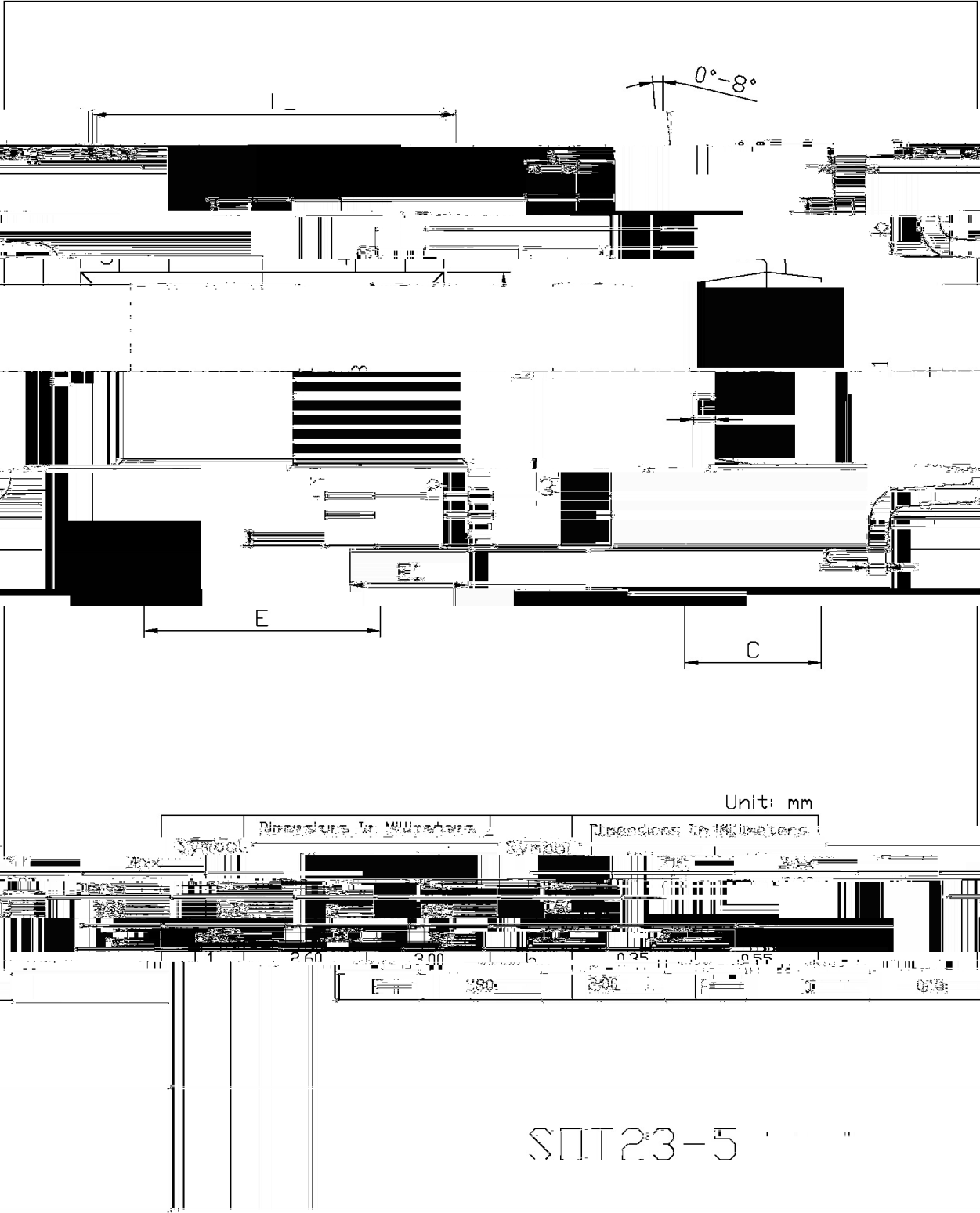
/Abnormal Charge Detection



Notes: (1) Normal condition (2) Overcharge voltage condition (3) Overdischarge voltage condition (4) Overcurrent condition

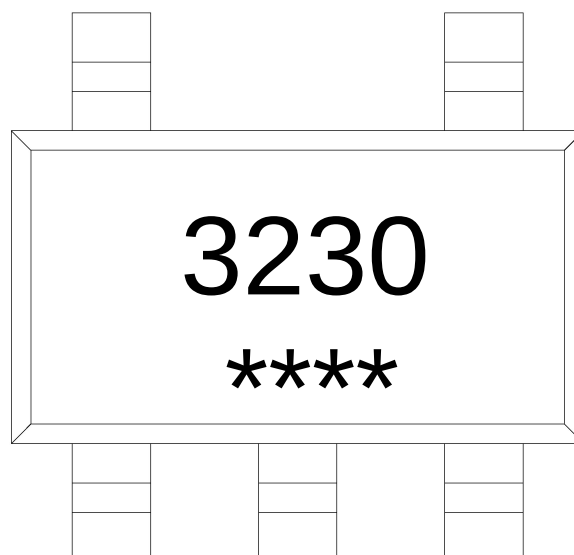


/ Package Dimensions





/ Marking Instructions



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Note:

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Product Type.

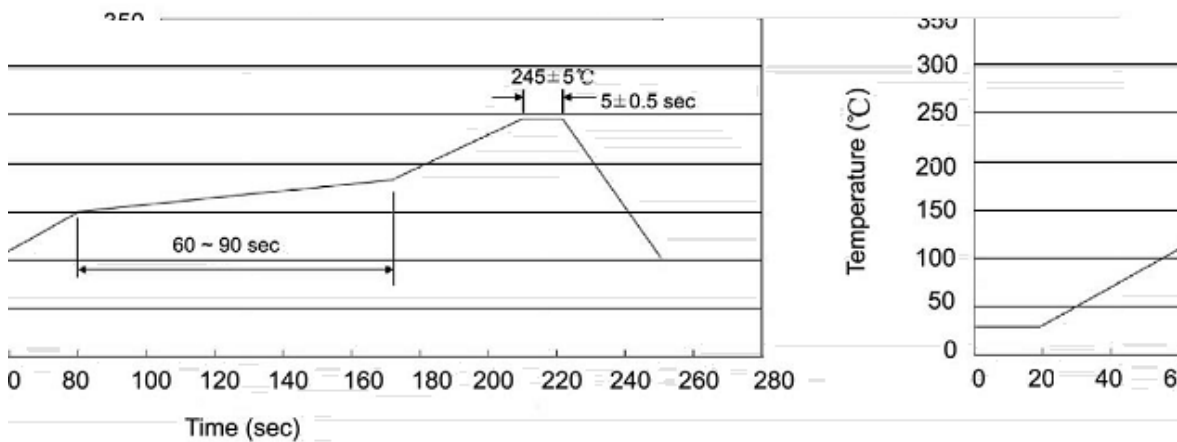
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Product Type.

Lot No. Code, code change with Lot No.



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



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1 Ď Ť Ÿ Ä 150 Φ 180 X 60 Φ 90 sec;

2 Ď Ψ ě Ä 245 Ω 5 X Ń ŋ ¥ 5 Ω 0.5 sec;

3 Ď æ ç ķ ĩ Ÿ á ¥ 2 Φ 10 X / sec.

Note:

1. Preheating: 150~180 X, Time: 60~90 sec.

2. Peak Temp.: 245 Ω 5 X, Duration: 5 Ω 0.5 sec.

3. Cooling Speed: 2~10 X / sec.

/ Resistance to Soldering Heat Test Conditions

Ä Æ 260 Ω 5 X

Æ 10 Ω 1 sec.

Temp.: 260 Ω 5 X

Time: 10 Ω 1 sec

/ Packaging SPEC.

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SOT23-5/6	3,000	10	30,000	4	120,000	7" × 8	210 × 205 × 205	435 × 225 × 420

/ Notices